

## STATUS OF THE CLAIMS

The status of the claims of the current application stands as follows:

Claims 1-6: **(Canceled)**

7. **(Currently Amended)** An integrated redundancy architecture for providing BIST redundancy allocation to an embedded memory system, the architecture comprising:
- a BIST for identifying and transmitting row and column addresses ~~from~~ of  
corresponding respective failed memory cells of embedded memory;
  - a first memory element for storing, as to-be-repaired row addresses, ones of the row  
addresses that have been assigned for repair by row redundancy;
  - a second memory element for storing, as to-be-repaired column addresses, ones of the  
column addresses that have been assigned for repair by column redundancy;
  - a third memory element for accumulating ones of the row and column addresses not  
already contained in said first and second memory elements and for assigning each  
of the failed row and column addresses a particular weight value based on the  
number of the failed row and column addresses already accumulated in said third  
memory element and the relative locations of said failed row and column addresses  
within the memory system; and
- ~~means for assigning ones of the failed row and column addresses having weights~~  
~~greater than a threshold for permanent storage in said first or second memory element;~~  
determining whether the row address of a failed memory cell matches any of the  
to-be-repaired row addresses stored in the first memory element;  
determining whether the column address of the failed memory cell matches any  
of the to-be-repaired column addresses stored in the second memory element;  
if the row address of the failed memory cell does not match any of the to-be-  
repaired row addresses stored in the first memory element and the column  
address of the failed memory cell does not match any of the to-be-repaired  
column addresses stored in the second memory element, storing the row and  
column addresses of the failed memory cell in the third memory element;  
if either the row address of the failed memory cell matches one of the to-be-  
repaired row addressed stored in the first memory element or the column

address of the failed memory cell matches one of the to-be-repaired column addresses stored in the second memory element, or both, then:

determining whether the row address of another failed memory cell matches any of the to-be-repaired row addresses stored in the first memory element; and

determining whether the column address of the another failed memory cell matches any of the to-be-repaired column addresses stored in the second memory element.

8. **(Previously Presented)** An integrated redundancy architecture according to claim 7, wherein said first, second, and third memory elements include the function of content addressable memory.
9. **(Previously Presented)** An integrated redundancy architecture according to claim 7, wherein said first memory element includes a register for storing row addresses that have been assigned for repair by row redundancy.
10. **(Previously Presented)** An integrated redundancy architecture according to claim 7, wherein said second memory element includes a register for storing column addresses that have been assigned for repair by column redundancy.
11. **(Previously Presented)** An integrated redundancy architecture according to claim 7, wherein said third memory element includes a register for accumulating the failed row and column addresses transmitted from said BIST.
12. **(Previously Presented)** An integrated redundancy architecture according to claim 7, further comprising a finite state machine having a decision algorithm, said finite state machine in electrical communication with said first memory element, said second memory element, and said third memory element.
13. **(Previously Presented)** An integrated redundancy architecture according to claim 12, wherein said finite state machine allocates redundancy resources of said memory system according to said decision algorithm.

14. **(Currently Amended)** A method of providing BIST redundancy allocation to an embedded memory system, comprising the steps of:
- a. identifying failed row and column addresses of defective memory blocks in said embedded memory system;
  - b. accumulating said failed row and column addresses identified in step a in a third memory element;
  - c. assigning failed row and column addresses accumulated in step b a particular weight values based on the number of like addresses already accumulated and their relative locations within the memory system; and
  - d. transferring said failed row and column addresses associated with the most fails from said third memory element to first and second memory elements according to a decision algorithm;
  - e. repairing said failed row addresses in the first memory element by assignment of redundant rows, and repairing said failed column addresses in the second memory element by assignment of redundant columns; and
  - f. reducing the corresponding row or column weight values of the remaining failed row and column addresses in the third memory element that share defective memory addresses with the repaired rows or columns.
15. **(Previously Presented)** A method according to claim 14, wherein at least one of said first, second, and third memory elements include content addressable memory.
16. **(Previously Presented)** A method according to claim 14, wherein said first memory element includes a register for storing said failed row addresses.
17. **(Previously Presented)** A method according to claim 14, wherein said second memory element includes a register for storing said failed column addresses.
18. **(Previously Presented)** A method according to claim 14, wherein said third memory element includes a register for accumulating said failed row and column addresses transmitted from the BIST.
19. **(Previously Presented)** A method according to claim 14, wherein said steps c and d include using a finite state machine having a decision algorithm, said finite state machine

being in electrical communication with said first memory element, said second memory element, and said third memory element.

20. **(Previously Presented)** A method according to claim 19, wherein said finite state machine allocates redundancy resources of said memory system according to said decision algorithm.

21. **(Currently Amended)** An integrated circuit comprising:

an embedded memory system having a plurality of row and column redundancies;  
a BIST for identifying row and column addresses of defective memory blocks in said embedded memory system;

a first memory element to store row addresses repaired by row redundancy;

a second memory element to store column addresses repaired by column redundancy; and

a third memory element for accumulating said row and column addresses identified by said BIST and assigning them a particular row or column weight value based on the number of like addresses already accumulated and still resident in said third memory element and their relative locations within the memory system; and

means for:

determining whether the row address of a failed memory cell matches any of the to-be-repaired row addresses stored in the first memory element;

determining whether the column address of the failed memory cell matches any of the to-be-repaired column addresses stored in the second memory element;

if the row address of the failed memory cell does not match any of the to-be-repaired row addresses stored in the first memory element and the column address of the failed memory cell does not match any of the to-be-repaired column addresses stored in the second memory element, storing the row and column addresses of the failed memory cell in the third memory element;

if either the row address of the failed memory cell matches one of the to-be-repaired row addresses stored in the first memory element or the column address of the failed memory cell matches one of the to-be-repaired column addresses stored in the second memory element, or both, then:

determining whether the row address of another failed memory cell matches any of the to-be-repaired row addresses stored in the first memory element; and  
determining whether the column address of the another failed memory cell matches any of the to-be-repaired column addresses stored in the second memory element.

22. **(Previously Presented)** An integrated circuit according to claim 21, further comprising a finite state machine having a decision algorithm, said finite state machine in electrical communication with said first memory element, said second memory element, and said third memory element.
23. **(Previously Presented)** An integrated circuit according to claim 22, wherein said finite state machine allocates redundancy resources of said memory system according to said decision algorithm.
24. **(Previously Presented)** An integrated circuit according to claim 21, wherein at least one of said first, second, and third memory elements include content addressable memory.
25. **(Previously Presented)** An integrated circuit according to claim 21, wherein said first memory element includes a register for storing said failed row addresses.
26. **(Previously Presented)** An integrated circuit according to claim 21, wherein said second memory element includes a register for storing said failed column addresses.